INTEGRATED CIRCUITS

DATA SHEET

TJA1054Fault-tolerant CAN transceiver

Product specification Supersedes data of 1999 Feb 11 File under Integrated Circuits, IC18 2001 Nov 20





Fault-tolerant CAN transceiver

TJA1054

FEATURES

Optimized for in-car low-speed communication

- · Baud rate up to 125 kBaud
- Up to 32 nodes can be connected
- · Supports unshielded bus wires
- Very low ElectroMagnetic Emission (EME) due to built-in slope control function and a very good matching of the CANL and CANH bus outputs
- Good ElectroMagnetic Immunity (EMI) in normal operating mode and in low power modes
- · Fully integrated receiver filters
- Transmit Data (TxD) dominant time-out function.

Bus failure management

- Supports single-wire transmission modes with ground offset voltages up to 1.5 V
- \bullet Automatic switching to single-wire mode in the event of bus failures, even when the CANH bus wire is short-circuited to V_{CC}
- Automatic reset to differential mode if bus failure is removed
- Full wake-up capability during failure modes.

Protections

- · Bus pins short-circuit safe to battery and to ground
- Thermally protected
- Bus lines protected against transients in an automotive environment
- An unpowered node does not disturb the bus lines.

Support for low power modes

- Low current sleep and standby mode with wake-up via the bus lines
- · Power-on reset flag on the output.

ORDERING INFORMATION

TYPE		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
TJA1054T	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
TJA1054U	_	bare die; 2000 × 2830 × 375 μm	_

GENERAL DESCRIPTION

The TJA1054 is the interface between the protocol controller and the physical bus wires in a Controller Area Network (CAN). It is primarily intended for low-speed applications up to 125 kBaud in passenger cars. The device provides differential receive and transmit capability but will switch to single-wire transmitter and/or receiver in error conditions.

The TJA1054T is pin and downwards compatible with the PCA82C252T and the TJA1053T. This means that these two devices can be replaced by the TJA1054T with retention of all functions.

The most important improvements of the TJA1054 with respect to the PCA82C252 and the TJA1053 are:

- Very low EME due to a very good matching of the CANL and CANH output signals
- Good EMI, especially in low power modes
- Full wake-up capability during bus failures
- Extended bus failure management including short-circuit of the CANH bus line to V_{CC}
- · Support for easy system fault diagnosis
- Two-edge sensitive wake-up input signal via pin WAKE.

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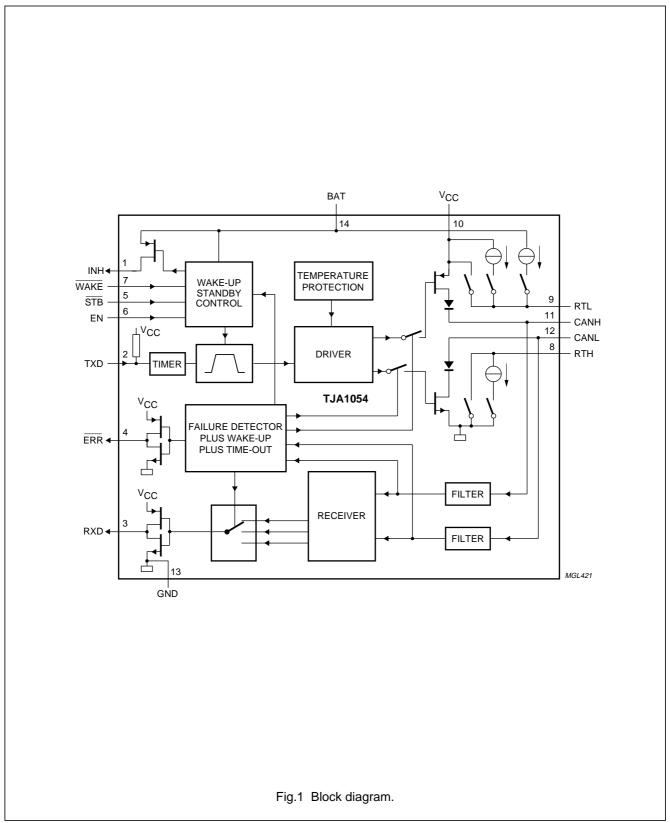
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{CC}	supply voltage on pin V _{CC}		4.75	-	5.25	V
V _{BAT}	battery voltage on pin BAT	no time limit	-0.3	Ī-	+40	V
		operating mode	5.0	_	27	V
		load dump	_	_	40	V
I _{BAT}	battery current on pin BAT	Sleep mode; V _{CC} = 0 V; V _{BAT} = 12 V	_	30	50	μА
V _{CANH}	CANH bus line voltage	$V_{CC} = 0$ to 5.5 V; $V_{BAT} \ge 0$ V; no time limit	-40	_	+40	V
V _{CANL}	CANL bus line voltage	$V_{CC} = 0$ to 5.5 V; $V_{BAT} \ge 0$ V; no time limit	-40	_	+40	V
ΔV_{CANH}	CANH bus line transmitter voltage drop	I _{CANH} = -40 mA	_	_	1.4	V
ΔV_{CANL}	CANL bus line transmitter voltage drop	I _{CANL} = 40 mA	_	_	1.4	V
t _{PD(L)}	propagation delay TXD (LOW) to RXD (LOW)		_	1	_	μs
t _r	bus line output rise time	between 10% and 90%; C1 = 10 nF; see Fig.5	-	0.6	_	μs
t _f	bus line output fall time	between 90% and 10%; C1 = 1 nF; see Fig.5	-	0.3	_	μs
T _{vj}	virtual junction temperature		-40	_	+150	°C

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BLOCK DIAGRAM

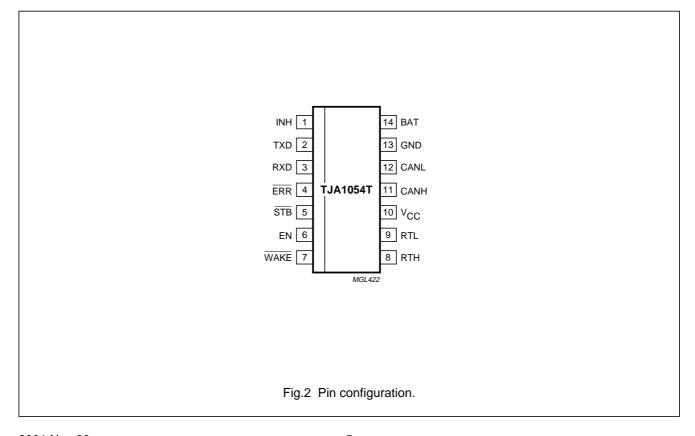


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PINNING

SYMBOL	PIN	DESCRIPTION
INH	1	inhibit output for switching an external voltage regulator if a wake-up signal occurs
TXD	2	transmit data input for activating the driver to the bus lines
RXD	3	receive data output for reading out the data from the bus lines
ERR	4	error, wake-up and power-on indication output; active LOW in normal operating mode when the bus has a failure, and in low power modes (wake-up signal or in power-on standby)
STB	5	standby digital control signal input (active LOW); together with the input signal on pin EN this input determines the state of the transceiver (in normal and low power modes); see Table 2 and Fig.3
EN	6	enable digital control signal input; together with the input signal on pin STB this input determines the state of the transceiver (in normal and low power modes); see Table 2 and Fig.3
WAKE	7	local wake-up signal input (active LOW); both falling and rising edges are detected
RTH	8	termination resistor connection; in case of a CANH bus wire error the line is terminated with a predefined impedance
RTL	9	termination resistor connection; in case of a CANL bus wire the line is terminated with a predefined impedance
V _{CC}	10	supply voltage
CANH	11	HIGH-level CAN bus line
CANL	12	LOW-level CAN bus line
GND	13	ground
BAT	14	battery voltage connection



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FUNCTIONAL DESCRIPTION

The TJA1054 is the interface between the CAN protocol controller and the physical wires of the CAN bus (see Fig.7). It is primarily intended for low speed applications, up to 125 kBaud, in passenger cars. The device provides differential transmit capability to the CAN bus and differential receive capability to the CAN controller.

To reduce EME, the rise and fall slopes are limited. This allows the use of an unshielded twisted pair or a parallel pair of wires for the bus lines. Moreover, the device supports transmission capability on either bus line if one of the wires is corrupted. The failure detection logic automatically selects a suitable transmission mode.

In normal operating mode (no wiring failures) the differential receiver is output on pin RXD (see Fig.1). The differential receiver inputs are connected to pins CANH and CANL through integrated filters. The filtered input signals are also used for the single-wire receivers. The receivers connected to pins CANH and CANL have threshold voltages that ensure a maximum noise margin in single-wire mode.

A timer function (TxD dominant time-out function) has been integrated to prevent the bus lines from being driven into a permanent dominant state (thus blocking the entire network communication) due to a situation in which pin TXD is permanently forced to a LOW level, caused by a hardware and/or software application failure.

If the duration of the LOW level on pin TXD exceeds a certain time, the transmitter will be disabled. The timer will be reset by a HIGH level on pin TXD.

Failure detector

The failure detector is fully active in the normal operating mode. After the detection of a single bus failure the detector switches to the appropriate mode (see Table 1). The differential receiver threshold voltage is set at -3.2 V typical ($V_{CC} = 5$ V). This ensures correct reception with a noise margin as high as possible in the normal operating mode and in the event of failures 1, 2, 5 and 6a. These failures, or recovery from them, do not destroy ongoing transmissions. The output drivers remain active, the termination does not change and the receiver remains in differential mode (see Table 1).

Failures 3, 3a and 6 are detected by comparators connected to the CANH and CANL bus lines.
Failures 3 and 3a are detected in a two-step approach. If the CANH bus line exceeds a certain voltage level, the differential comparator signals a continuous dominant condition. Because of inter-operability reasons with the predecessor products PCA82C252 and TJA1053, after a first time-out the transceiver switches to single wire operation through CANH. If the CANH bus line is still exceeding the CANH detection voltage for a second time-out, the TJA1054 switches to CANL operation; the CANH driver is switched off and the RTH bias changes to the pull-down current source. The time-outs (delays) are needed to avoid false triggering by external RF fields.

Table 1 Bus failures

FAILURE	DESCRIPTION	TERMINATION CANH (RTH)	TERMINATION CANL (RTL)	CANH DRIVER	CANL DRIVER	RECEIVER MODE
1	CANH wire interrupted	on	on	on	on	differential
2	CANL wire interrupted	on	on	on	on	differential
3	CANH short-circuited to battery	weak; note 1	on	off	on	CANL
3a	CANH short-circuited to V _{CC}	weak; note 1	on	off	on	CANL
4	CANL short-circuited to ground	on	weak; note 2	on	off	CANH
5	CANH short-circuited to ground	on	on	on	on	differential
6	CANL short-circuited to battery	on	weak; note 2	on	off	CANH
6a	CANL short-circuited to V _{CC}	on	on	on	on	differential
7	CANL and CANH mutually short-circuited	on	weak; note 2	on	off	CANH

Notes

- 1. A weak termination implies a pull-down current source behaviour of 75 μA typical.
- 2. A weak termination implies a pull-up current source behaviour of 75 μA typical.

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Failure 6 is detected if the CANL bus line exceeds its comparator threshold for a certain period of time. This delay is needed to avoid false triggering by external RF fields. After detection of failure 6, the reception is switched to the single wire mode through CANH; the CANL driver is switched off and the RTL bias changes to the pull-up current source.

Recovery from failures 3, 3a and 6 is detected automatically after reading a consecutive recessive level by corresponding comparators for a certain period of time.

Failures 4 and 7 initially result in a permanent dominant level on pin RXD. After a time-out the CANL driver is switched off and the RTL bias changes to the pull-up current source. Reception continues by switching to the single-wire mode via pins CANH or CANL. When failures 4 or 7 are removed, the recessive bus levels are restored. If the differential voltage remains below the recessive threshold level for a certain period of time, reception and transmission switch back to the differential mode.

If any of the wiring failures occur, the output signal on pin ERR will be set to LOW. On error recovery, the output signal on pin ERR will be set to HIGH again. In case of an interrupted open bus wire, this failure will be detected and signalled only if there is an open wire between the

Table 2 Normal operating and low power modes

transmitting and receiving node(s). Thus, during open wire failures, pin ERR typically toggles.

During all single-wire transmissions, EMC performance (both immunity and emission) is worse than in the differential mode. The integrated receiver filters suppress any HF noise induced into the bus wires. The cut-off frequency of these filters is a compromise between propagation delay and HF suppression. In single-wire mode, LF noise cannot be distinguished from the required signal.

Low power modes

The transceiver provides three low power modes which can be entered and exited via pins STB and EN (see Table 2 and Fig.3).

The Sleep mode is the mode with the lowest power consumption. Pin INH is switched to high-impedance for deactivation of the external voltage regulator. Pin CANL is biased to the battery voltage via pin RTL. If the supply voltage is provided, pins RXD and ERR will signal the wake-up interrupt.

The standby mode operates in the same way as the Sleep mode but with a HIGH level on pin INH.

	PIN	PIN	PIN ERI	R	
MODE	STB	EN	LOW	HIGH	

	PIN	PIN	PIN ER	R	PIN R	XD	PIN RTL
MODE	STB	EN	LOW	HIGH	LOW	HIGH	SWITCHED TO
Goto-sleep command	LOW	HIGH	wake-up interrupt signal;		wake-up interrupt signal;		V_{BAT}
Sleep	LOW	LOW ⁽³⁾	notes 1 and 2		notes 1 and 2		
Standby	LOW	LOW					
Power-on standby	HIGH	LOW	V _{BAT} power-on flag; notes 1 and 4		wake-up interrupt signal; notes 1 and 2		V_{BAT}
Normal operating	HIGH	HIGH	error flag	no error flag	dominant received data	recessive received data	V _{CC}

Notes

- 1. If the supply voltage V_{CC} is present.
- 2. Wake-up interrupts are released when entering normal operating mode.
- 3. In case the goto-sleep command was used before. When V_{CC} drops pin EN will become LOW, but due to the fail-safe functionality this does not effect the internal functions.
- 4. V_{BAT} power-on flag will be reset when entering normal operating mode.

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The power-on standby mode is the same as the standby mode, however, in this mode the battery power-on flag is shown on pin $\overline{\mathsf{ERR}}$ instead of the wake-up interrupt signal. The output on pin RXD will show the wake-up interrupt. This mode is only for reading out the power-on flag.

Wake-up requests are recognized by the transceiver through two possible channels:

- The bus lines for remote wake-up
- Pin WAKE for local wake-up.

In order to wake-up the transceiver remotely through the bus lines, a filter mechanism is integrated. This mechanism makes sure that noise and any present bus failure conditions do not result into an erroneous wake-up. Because of this mechanism it is not sufficient to simply pull the CANH or CANL bus lines to a dominant level for a certain time. To guarantee a successful remote wake-up under all conditions, a message frame with a dominant phase of at least the maximum specified t_{CANH} or t_{CANL} in it is required.

A local wake-up through pin \overline{WAKE} is detected by a rising or falling edge with a consecutive level with the maximum specified t_{WAKE} .

On a wake-up request the transceiver will set the output on pin INH to HIGH which can be used to activate the external supply voltage regulator.

If V_{CC} is present the wake-up request can be read on the \overline{ERR} or RXD outputs, so the external microcontroller can activate the transceiver (switch to normal operating mode) via pins \overline{STB} and EN.

To prevent a false remote wake-up due to transients or RF fields, the wake-up voltage levels have to be maintained for a certain period of time. In the low power modes the failure detection circuit remains partly active to prevent an increased power consumption in the event of failures 3, 3a, 4 or 7.

To prevent a false local wake-up during an open wire at pin \overline{WAKE} , this pin has a weak pull-up current source towards V_{BAT} . Pin INH is set to floating only if the goto-sleep command is entered successfully. To enter a successful goto-sleep command under all conditions, this command must be kept stable for the maximum specified $t_{h(sleep)}$.

Pin INH will be set to a HIGH level again by the following events only:

- V_{BAT} power-on (cold start)
- Rising or falling edge on pin WAKE
- A message frame with a dominant phase of at least the maximum specified t_{CANH} or t_{CANL}, while pin EN or pin STB is at a LOW level
- Pin STB goes to a HIGH level with V_{CC} active.

To provide fail-safe functionality, the signals on pins \overline{STB} and EN will internally be set to LOW when V_{CC} is below a certain threshold voltage ($V_{CC(stb)}$).

Power-on

After power-on (V_{BAT} switched on) the signal on pin INH will become HIGH and an internal power-on flag will be set. This flag can be read in the power-on standby mode through pin \overline{ERR} ($\overline{STB}=1$; EN=0) and will be reset by entering the normal operating mode.

Protection

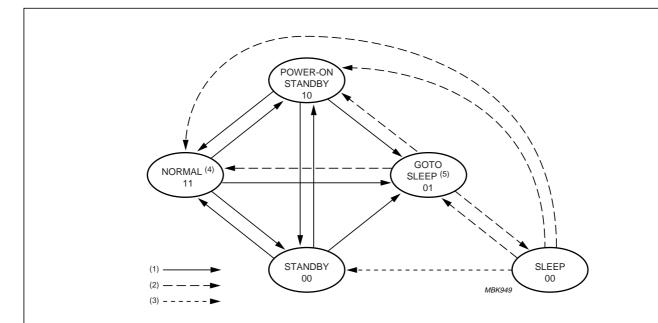
A current limiting circuit protects the transmitter output stages against short-circuit to positive and negative battery voltage.

If the junction temperature exceeds the typical value of 165 °C, the transmitter output stages are disabled. Because the transmitter is responsible for the major part of the power dissipation, this will result in a reduced power dissipation and hence a lower chip temperature. All other parts of the device will continue to operate.

The pins CANH and CANL are protected against electrical transients which may occur in an automotive environment.

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Mode 10 stands for: pin \overline{STB} = HIGH and pin EN = LOW.

- (1) Mode change via input pins $\overline{\text{STB}}$ and EN.
- (2) Mode change via input pins STB and EN; it should be noted that in the sleep mode pin INH is inactive and possibly there is no V_{CC}. Mode control is only possible if V_{CC} of the transceiver is active.
- (3) Pin INH is activated after wake-up via bus or input pin $\overline{\text{WAKE}}.$
- (4) Transitions to normal mode clear the internal wake-up: interrupt and battery fail flag are cleared.
- (5) Transitions to sleep mode: pin INH is deactivated.

Fig.3 Mode control.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134); note 1.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CC}	supply voltage on pin V _{CC}		-0.3	+6	V
V _{BAT}	battery voltage on pin BAT		-0.3	+40	V
V _n	DC voltage on pins TXD, RXD, ERR, STB and EN		-0.3	V _{CC} + 0.3	V
V _{CANH}	DC voltage on pin CANH		-40	+40	V
V _{CANL}	DC voltage on pin CANL		-40	+40	V
V _{trt(n)}	transient voltage on pins CANH and CANL	see Fig.6	-150	+100	V
V _{WAKE}	DC voltage on pin WAKE		-	V _{BAT} + 0.3	V
I _{WAKE}	DC current on pin WAKE	note 2	-15	_	mA
V _{INH}	DC voltage on pin INH		-0.3	V _{BAT} + 0.3	V
V _{RTH}	DC voltage on pin RTH		-0.3	V _{BAT} + 1.2	V
V _{RTL}	DC voltage on pin RTL		-0.3	V _{BAT} + 1.2	V
R _{RTH}	termination resistance on pin RTH		500	16000	Ω
R _{RTL}	termination resistance on pin RTL		500	16000	Ω
T _{vj}	virtual junction temperature	note 3	-40	+150	°C
T _{stg}	storage temperature		-55	+150	°C
V _{esd}	electrostatic discharge voltage	human body model; note 4	-2	+2	kV
		machine model; note 5	-175	+175	V

Notes

- 1. All voltages are defined with respect to pin GND. Positive current flows into the device.
- 2. Only relevant if $V_{WAKE} < V_{GND} 0.3 V$; current will flow into pin GND.
- 3. Junction temperature in accordance with IEC 60747-1. An alternative definition is: $T_{vj} = T_{amb} + P \times R_{th(vj-a)}$ where $R_{th(vj-a)}$ is a fixed value to be used for the calculation of T_{vj} . The rating for T_{vj} limits the allowable combinations of power dissipation (P) and operating ambient temperature (T_{amb}).
- 4. Equivalent to discharging a 100 pF capacitor through a 1.5 k Ω resistor.
- 5. Equivalent to discharging a 200 pF capacitor through a 10 Ω resistor and a 0.75 μ H coil.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	120	K/W
R _{th(j-s)}	thermal resistance from junction to substrate bare die	in free air	40	K/W

QUALITY SPECIFICATION

Quality specification in accordance with "SNW-FQ-611D".

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DC CHARACTERISTICS

 V_{CC} = 4.75 to 5.25 V; V_{BAT} = 5 to 27 V; V_{STB} = V_{CC} ; T_{vj} = -40 to +150 °C; all voltages are defined with respect to ground; positive currents flow into the device; unless otherwise specified; notes 1 and 2.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supplies (p	ins V _{CC} and BAT)		1	-	-	
V _{CC}	supply voltage on pin V _{CC}		4.75	_	5.25	V
V _{CC(stb)}	supply voltage for forced standby mode (fail-safe)		2.75	-	4.5	V
I _{CC}	supply current	normal operating mode; V _{TXD} = V _{CC} (recessive)	4	7	11	mA
		normal operating mode; V _{TXD} = 0 V (dominant); no load	10	17	27	mA
		low power modes; V _{TXD} = V _{CC}	0	0	10	μΑ
V _{BAT}	battery voltage on pin BAT	no time limit	-0.3	_	+40	V
		operating mode	5.0	_	27	V
		load dump	_	_	40	V
I _{BAT}	battery current on pin BAT	all modes and in low power modes at V _{RTL} = V _{BAT} ; V _{WAKE} = V _{INH} = V _{BAT}				
		V _{BAT} = 12 V	10	30	50	μΑ
		$V_{BAT} = 5 \text{ to } 27 \text{ V}$	5	30	125	μΑ
		$V_{BAT} = 3.5 V$	5	20	30	μΑ
		V _{BAT} = 1 V	0	0	10	μΑ
$V_{BAT(Pwon)}$	power-on flag voltage on	low power modes				
	pin BAT	power-on flag set	_	_	1	V
		power-on flag not set	3.5	_	_	V
I _{tot}	supply current plus battery current	low power modes; $V_{CC} = 5 \text{ V};$ $V_{BAT} = V_{WAKE} = V_{INH} = 12 \text{ V}$	-	30	60	μА
Pins STB, E	EN and TXD		•	•		
V _{IH}	HIGH-level input voltage		0.7V _{CC}	_	V _{CC} + 0.3	V
V _{IL}	LOW-level input voltage		-0.3	_	0.3V _{CC}	V
I _{IH}	HIGH-level input current	V _I = 4 V				
	pins STB and EN		_	9	20	μΑ
	pin TXD		-200	-80	-25	μΑ
I _{IL}	LOW-level input current	V _I = 1 V				
	pins STB and EN		4	8	_	μΑ
	pin TXD		-800	-320	-100	μΑ

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Pins RXD a	nd ERR		1	!	!	1
V _{OH}	HIGH-level output voltage					
	on pin ERR	$I_{O} = -100 \mu A$	V _{CC} – 0.9	_	V _{CC}	V
	on pin RXD	$I_O = -1 \text{ mA}$	V _{CC} – 0.9	_	V _{CC}	V
V _{OL}	LOW-level output voltage on	I _O = 1.6 mA	0	_	0.4	V
	pins ERR and RXD	I _O = 7.5 mA	0	_	1.5	V
Pin WAKE					1	1
I _{IL}	LOW-level input current	V _{WAKE} = 0 V; V _{BAT} = 27 V	-10	-4	-1	μΑ
V _{th(wake)}	wake-up threshold voltage	$V_{STB} = 0 \text{ V}$	2.5	3.2	3.9	V
Pin INH		1 0.5		l.	I	1
ΔV_{H}	HIGH-level voltage drop	I _{INH} = -0.18 mA	_	_	0.8	V
	leakage current	Sleep mode; V _{INH} = 0 V	_	_	5	μΑ
Pins CANH		C.OOPOOS, VIIVIT O			1	l bes :
V _{th(dif)}	differential receiver threshold	no failures and				
	voltage	bus failures 1, 2, 5 and 6a; see Fig.4				
		V _{CC} = 5 V	-3.5	-3.2	-2.9	V
		$V_{CC} = 4.75 \text{ to } 5.25 \text{ V}$	-0.70V _{CC}	-0.64V _{CC}	-0.58V _{CC}	V
V _{O(reces)}	recessive output voltage	$V_{TXD} = V_{CC}$				
	on pin CANH	$R_{RTH} < 4 k\Omega$	_	_	0.2	V
	on pin CANL	$R_{RTL} < 4 \text{ k}\Omega$	V _{CC} – 0.2	_	_	V
$V_{O(dom)}$	dominant output voltage	$V_{TXD} = 0 V; V_{EN} = V_{CC}$				
	on pin CANH	$I_{CANH} = -40 \text{ mA}$	V _{CC} – 1.4	_	_	V
	on pin CANL	I _{CANL} = 40 mA	_	_	1.4	V
I _{O(CANH)}	output current on pin CANH	normal operating mode; V _{CANH} = 0 V; V _{TXD} = 0 V	–110	-80	-45	mA
		low power modes; V _{CANH} = 0 V; V _{CC} = 5 V	_	-0.25	_	μΑ
I _{O(CANL)}	output current on pin CANL	normal operating mode; V _{CANL} = 14 V; V _{TXD} = 0 V	45	70	100	mA
		low power modes; V _{CANL} = 12 V; V _{BAT} = 12 V	_	0	_	μΑ
V _{d(CANH)(sc)}	detection voltage for	normal operating mode	1.5	1.7	1.85	V
2(21)(22)	short-circuit to battery voltage on pin CANH	low power modes	1.1	1.8	2.5	V
V _{d(CANL)(sc)}	detection voltage for	normal operating mode				
	short-circuit to battery voltage	V _{CC} = 5 V	6.6	7.2	7.8	V
	on pin CANL	$V_{CC} = 4.75 \text{ to } 5.25 \text{ V}$	1.32V _{CC}	1.44V _{CC}	1.56V _{CC}	V
V _{th(wake)}	wake-up threshold voltage	low power modes				
	on pin CANL		2.5	3.2	3.9	V
	on pin CANH		1.1	1.8	2.5	V

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$\Delta V_{th(wake)}$	difference of wake-up threshold voltages	low power modes	0.8	1.4	_	V
V _{th(CANH)(se)}	single-ended receiver threshold voltage on	normal operating mode; failures 4, 6 and 7				
	pin CANH	V _{CC} = 5 V	1.5	1.7	1.85	V
		$V_{CC} = 4.75 \text{ to } 5.25 \text{ V}$	0.30V _{CC}	0.34V _{CC}	0.37V _{CC}	V
$V_{th(CANL)(se)}$	single-ended receiver threshold voltage on pin CANL	normal operating mode; failures 3 and 3a				
		V _{CC} = 5 V	3.15	3.3	3.45	V
		$V_{CC} = 4.75 \text{ to } 5.25 \text{ V}$	0.63V _{CC}	0.66V _{CC}	0.69V _{CC}	V
R _{i(CANH)(se)}	single-ended input resistance on pin CANH	normal operating mode	110	165	270	kΩ
R _{i(CANL)(se)}	single-ended input resistance on pin CANL	normal operating mode	110	165	270	kΩ
R _{i(dif)}	differential input resistance	normal operating mode	220	330	540	kΩ
Pins RTH ar	nd RTL					
R _{sw(RTL)}	switch-on resistance between pin RTL and V _{CC}	normal operating mode; I _O < 10 mA	_	50	100	Ω
R _{sw(RTH)}	switch-on resistance between pin RTH and ground	normal operating mode; I _O < 10 mA	_	50	100	Ω
V _{O(RTH)}	output voltage on pin RTH	low power modes; I _O = 1 mA	_	0.7	1.0	V
I _{O(RTL)}	output current on pin RTL	low power modes; V _{RTL} = 0 V	-1.25	-0.65	-0.3	mA
I _{pu(RTL)}	pull-up current on pin RTL	normal operating mode; failures 4, 6 and 7	_	75	_	μΑ
I _{pd(RTH)}	pull-down current on pin RTH	normal operating mode; failures 3 and 3a	_	75	_	μΑ
Thermal sh	utdown	,	•	•	•	•
T _{j(sd)}	junction temperature for shut down		155	165	180	°C

Notes

- 1. All parameters are guaranteed over the virtual junction temperature range by design, but only 100% tested at $T_{amb} = 125$ °C for dies on wafer level, and in addition to this 100% tested at $T_{amb} = 25$ °C for cased products, unless otherwise specified.
- 2. For bare die, all parameters are only guaranteed if the back side of the die is connected to ground.

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TIMING CHARACTERISTICS

 V_{CC} = 4.75 to 5.25 V; V_{BAT} = 5 to 27 V; V_{STB} = V_{CC} ; T_{vj} = -40 to +150 °C; all voltages are defined with respect to ground; unless otherwise specified; notes 1 and 2

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$t_{t(r-d)}$	CANL and CANH output transition time for recessive to dominant	between 10% and 90%; R1 = 100 Ω; C1 = 10 nF; C2 not present; see Fig.5	0.35	0.60	-	μs
$t_{t(d-r)}$	CANL and CANH output transition time for dominant to recessive	between 10% and 90%; R1 = 100 Ω ; C1 = 1 nF; C2 not present; see Fig.5	0.2	0.3	_	μs
t _{PD(L)}	propagation delay TXD (LOW) to RXD (LOW)	no failures and failures 1, 2, 5 and 6a; R1 = 100 Ω ; see Figs 4 and 5				
		C1 = 1 nF; C2 not present	_	0.75	1.5	μs
		C1 = C2 = 3.3 nF	_	1	1.75	μs
		failures 3, 3a, 4, 6 and 7; R1 = 100 Ω; see Figs 4 and 5				
		C1 = 1 nF; C2 not present	_	0.85	1.4	μs
		C1 = C2 = 3.3 nF	_	1.1	1.7	μs
t _{PD(H)}	propagation delay TXD (HIGH) to RXD (HIGH)	no failures and failures 1, 2, 5 and 6a; R1 = 100Ω ; see Figs 4 and 5				
		C1 = 1 nF; C2 not present	_	1.2	1.9	μs
		C1 = C2 = 3.3 nF	-	2.5	3.3	μs
		failures 3, 3a, 4, 6 and 7; R1 = 100 Ω; see Figs 4 and 5				
		C1 = 1 nF; C2 not present	_	1.1	1.7	μs
		C1 = C2 = 3.3 nF	-	1.5	2.2	μs
t _{react(sleep)}	reaction time of goto-sleep command	note 3	5	_	50	μs
t _{dis(TxD)}	disable time of TxD permanent dominant timer	normal operating mode; V _{TXD} = 0 V	0.75	-	4	ms
t _{CANH}	dominant time for remote wake-up on pin CANH	low power modes; V _{BAT} = 12 V; note 3	7	_	38	μs
t _{CANL}	dominant time for remote wake-up on pin CANL	low power modes; V _{BAT} = 12 V; note 3	7	_	38	μs
t _{WAKE}	required time on pin WAKE for local wake-up	low power modes; V _{BAT} = 12 V; for wake-up after receiving a falling or rising edge; note 3	7	_	38	μs
t _{det}	failure detection time	normal operating mode				
		failures 3 and 3a	1.6	_	8.0	ms
		failures 4, 6 and 7	0.3	_	1.6	ms
		low power modes; V _{BAT} = 12 V				
		failures 3 and 3a	1.6	_	8.0	ms
		failures 4 and 7	0.1	_	1.6	ms

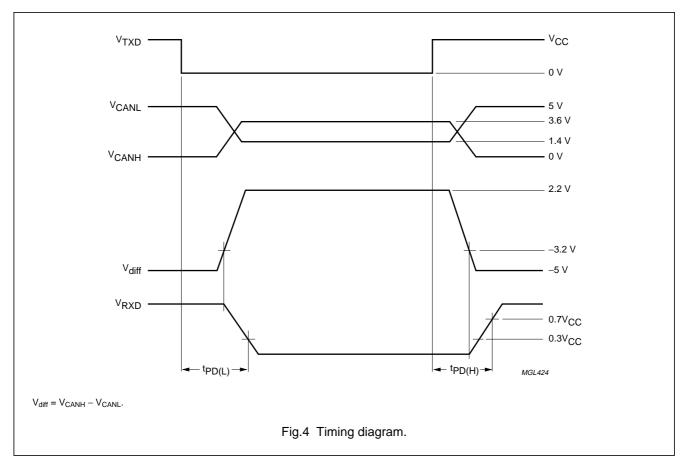
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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t _{rec}	failure recovery time	normal operating mode				
		failures 3 and 3a	0.3	_	1.6	ms
		failures 4 and 7	7	_	38	μs
		failure 6	125	_	750	μs
		low power modes; V _{BAT} = 12 V				
		failures 3, 3a, 4 and 7	0.3	_	1.6	ms
N _{det}	pulse-count difference between CANH and CANL for failure detection	normal operating mode and failures 1, 2, 5 and 6a; pin ERR becomes LOW	_	4	_	
N _{rec}	number of consecutive pulses on CANH and CANL simultaneously for failure recovery	failures 1, 2, 5 and 6a	_	4	_	

Notes

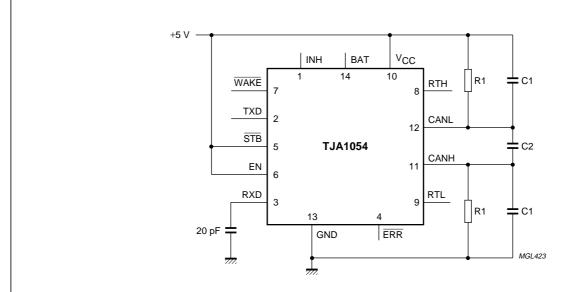
- 1. All parameters are guaranteed over the virtual junction temperature range by design, but only 100% tested at $T_{amb} = 125$ °C for dies on wafer level, and in addition to this 100% tested at $T_{amb} = 25$ °C for cased products, unless otherwise specified.
- 2. For bare die, all parameters are only guaranteed if the back side of the die is connected to ground.
- 3. To guarantee a successful mode transition under all conditions, the maximum specified time must be applied.



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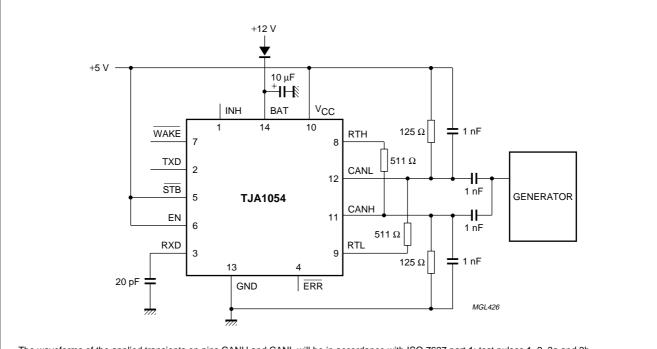
TEST AND APPLICATION INFORMATION



Termination resistors R1 (100 Ω) are not connected to pin RTH or pin RTL for testing purposes because the minimum load allowed on the CAN bus lines is 500 Ω per transceiver.

The capacitive bus load of 10 nF is split into 3 equal capacitors (3.3 nF) to simulate the bus cable.

Fig.5 Test circuit for dynamic characteristics.

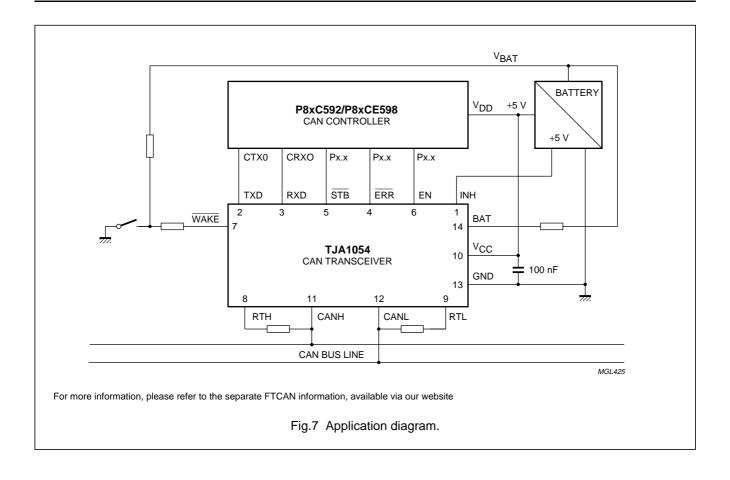


The waveforms of the applied transients on pins CANH and CANL will be in accordance with ISO 7637 part 1: test pulses 1, 2, 3a and 3b.

Fig.6 Test circuit for automotive transients.

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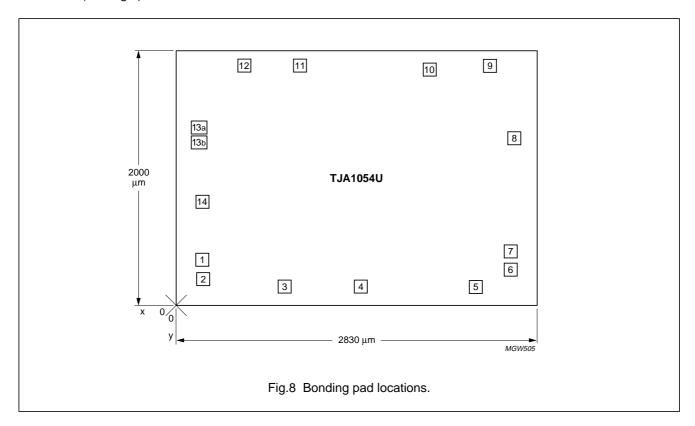
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BONDING PAD LOCATIONS

SYMBOL	DAD	COORDINATES ⁽¹⁾		
STWIBOL	PAD	х	у	
INH	1	206	357	
TXD	2	211	209	
RXD	3	850	151	
ERR	4	1447	151	
STB	5	5 2348 143		
EN	6	2621	280	
WAKE	7	2621	421	
RTH	8	2650 1309		
RTL	9	2459	1880	
V _{CC}	10	1986	1849	
CANH	11	972	1880	
CANL	12	537	1880	
GND	13a	180 1396		
GND	13b	180	1281	
BAT	14	206	812	

Note

1. All coordinates (μm) represent the position of the centre of each pad with respect to the bottom left-hand corner of the die (see Fig.8).



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0.3

0.028

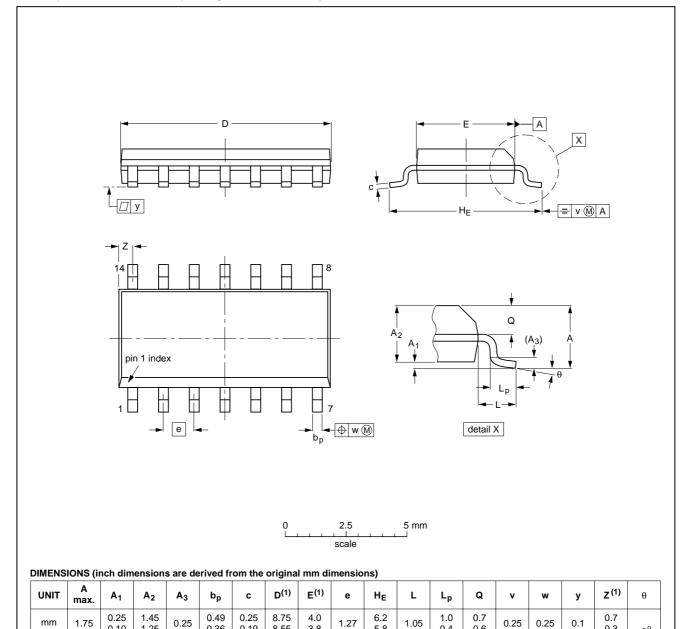
0.012

0°

PACKAGE OUTLINE

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

inches

0.069

0.010

0.004

0.057

0.049

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

0.01

0.19

0.35

0.34

0.019 0.0100 0.014 0.0075

OUTLINE	OUTLINE REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				97-05-22 99-12-27

0.050

0.244

0.228

0.041

0.039

0.016

0.028

0.024

0.01

0.01

0.004

3.8

0.16

0.15

2001 Nov 20 19

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SOLDERING

Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering can still be used for certain surface mount ICs, but it is not suitable for fine pitch SMDs. In these situations reflow soldering is recommended.

Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, convection or convection/infrared heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferable be kept below 220 °C for thick/large packages, and below 235 °C for small/thin packages.

Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
 - larger than or equal to 1.27 mm, the footprint longitudinal axis is preferred to be parallel to the transport direction of the printed-circuit board;
 - smaller than 1.27 mm, the footprint longitudinal axis must be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

 For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C. A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to $300\ ^{\circ}$ C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 $^{\circ}$ C.

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Suitability of surface mount IC packages for wave and reflow soldering methods

PACKAGE	SOLDERING METHOD		
PACKAGE	WAVE	REFLOW ⁽¹⁾	
BGA, HBGA, LFBGA, SQFP, TFBGA	not suitable	suitable	
HBCC, HLQFP, HSQFP, HSOP, HTQFP, HTSSOP, HVQFN, SMS	not suitable ⁽²⁾	suitable	
PLCC ⁽³⁾ , SO, SOJ	suitable	suitable	
LQFP, QFP, TQFP	not recommended ⁽³⁾⁽⁴⁾	suitable	
SSOP, TSSOP, VSO	not recommended ⁽⁵⁾	suitable	

Notes

- 1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the "Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods".
- 2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
- 3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
- 4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
- 5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

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DATA SHEET STATUS(1)	PRODUCT STATUS ⁽²⁾	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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NOTES

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Contact information

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